

Features

- Uses CRM(CQ) advanced Trench technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Qualified according to JEDEC criteria

Product Summary

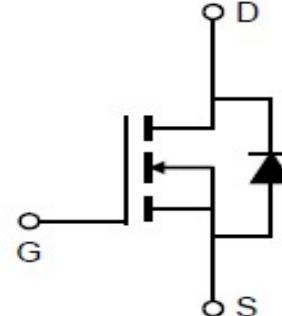
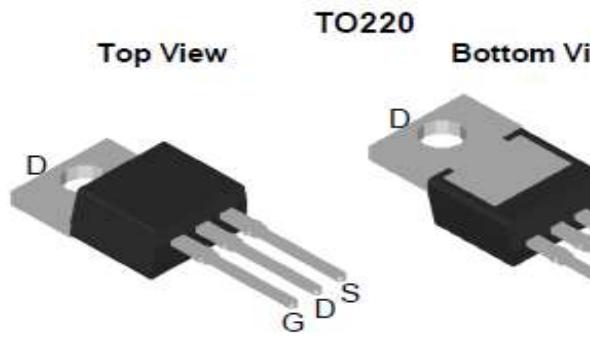
| | |
|-------------------|------|
| V_{DS} | 200V |
| $R_{DS(on)}$ typ. | 21mΩ |
| I_D | 65A |

Applications

- Motor control and drive
- Battery management
- UPS (Uninterruptible Power Supplies)

100% DVDS Tested

100% Avalanche Tested


Package Marking and Ordering Information

| Part # | Marking | Package | Packing | Reel Size | Tape Width | Qty |
|--------------|--------------|---------|---------|-----------|------------|-------|
| CRTT240N20NZ | CRTT240N20NZ | TO-220 | Tube | N/A | N/A | 50pcs |

Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|----------------------|-----------------|------|
| Drain-source voltage | V_{DS} | 200 | V |
| Continuous drain current $T_C = 25^\circ\text{C}$ (Silicon limit) $T_C = 25^\circ\text{C}$ (Package limit) $T_C = 100^\circ\text{C}$ (Silicon limit) | I_D | 65 160 41 | A |
| Pulsed drain current ($T_C = 25^\circ\text{C}$, t_p limited by $T_{j,\max}$) | $I_{D\text{ pulse}}$ | 260 | A |
| Avalanche energy, single pulse ($L=0.5\text{mH}$, $R_g=25\Omega$) | E_{AS} | 150 | mJ |
| Gate-Source voltage | V_{GS} | ± 20 | V |
| Power dissipation ($T_C = 25^\circ\text{C}$) | P_{tot} | 278 | W |
| Operating junction and storage temperature | T_j, T_{stg} | -55...+150 | °C |
| Soldering temperature, wave soldering only allowed at leads (1.6mm from case for 10s) | T_{sold} | 260 | °C |



CRTT240N20NZ

华润微电子(重庆)有限公司

Trench N-MOSFET 200V, 21mΩ, 65A

Thermal Resistance

| Parameter | Symbol | Max | Unit |
|--|---------------------|------|------|
| Thermal resistance, junction - case. | R _{thJC} | 0.45 | °C/W |
| Thermal resistance, junction - ambient(min. footprint) | R _{thJA} * | 62 | |

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

| Parameter | Symbol | Value | | | Unit | Test Condition |
|-----------|--------|-------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Static Characteristic

| | | | | | | |
|----------------------------------|---------------------|-----|-----|------|----|---|
| Drain-source breakdown voltage | BV _{DSS} | 200 | - | - | V | V _{GS} =0V, I _D =250uA |
| Gate threshold voltage | V _{GS(th)} | 3.0 | 4.0 | 5.0 | V | V _{DS} =V _{GS} , I _D =250uA |
| Zero gate voltage drain current | I _{DSS} | - | - | 10 | μA | V _{DS} =200V, V _{GS} =0V T _j =25°C T _j =150°C |
| Gate-source leakage current | I _{GSS} | - | - | ±100 | nA | V _{GS} =±20V, V _{DS} =0V |
| Drain-source on-state resistance | R _{DS(on)} | - | 21 | 26 | mΩ | V _{GS} =10V, I _D =30A, T _j =25°C T _j =150°C |
| Transconductance | g _{fs} | - | 77 | - | S | V _{DS} =5V, I _D =30A |

Dynamic Characteristic

| | | | | | | |
|------------------------------|---------------------|------|------|------|----|---|
| Input Capacitance | C _{iss} | 2095 | 4190 | 8380 | pF | V _{GS} =0V, V _{DS} =100V, f=1MHz |
| Output Capacitance | C _{oss} | 130 | 259 | 518 | | |
| Reverse Transfer Capacitance | C _{rss} | 21 | 41 | 82 | | |
| Gate Total Charge | Q _G | - | 74 | - | nC | V _{GS} =10V, V _{DS} =100V, I _D =30A, f=1MHz |
| Gate-Source charge | Q _{gs} | - | 28 | - | | |
| Gate-Drain charge | Q _{gd} | - | 23 | - | | |
| Turn-on delay time | t _{d(on)} | - | 28 | - | ns | V _{GS} =10V, V _{DD} =100V, R _{G_ext} =2.7Ω |
| Rise time | t _r | - | 76 | - | | |
| Turn-off delay time | t _{d(off)} | - | 63 | - | | |
| Fall time | t _f | - | 55 | - | | |
| Gate resistance | R _G | 0.2 | 5 | 10 | Ω | V _{GS} =0V, V _{DS} =0V, f=1MHz |



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Trench N-MOSFET 200V, 21mΩ, 65A

Body Diode Characteristic

| Parameter | Symbol | Value | | | Unit | Test Condition |
|------------------------------------|-----------------|-------|------|------|------|---|
| | | min. | typ. | max. | | |
| Body Diode Forward Voltage | V _{SD} | - | 0.8 | 1.3 | V | V _{GS} =0V, I _{SD} =30A |
| Body Diode Forward Current | I _S | | | 65 | A | T _C = 25°C |
| Body Diode Reverse Recovery Time | t _{rr} | - | 109 | - | ns | I _F =30A, dI/dt=100A/μs |
| Body Diode Reverse Recovery Charge | Q _{rr} | - | 587 | - | nC | |

*The value of R_{thJA} is measured by placing the device in a still air box which is one cubic foot.

Typical Performance Characteristics

Fig 1: Output Characteristics

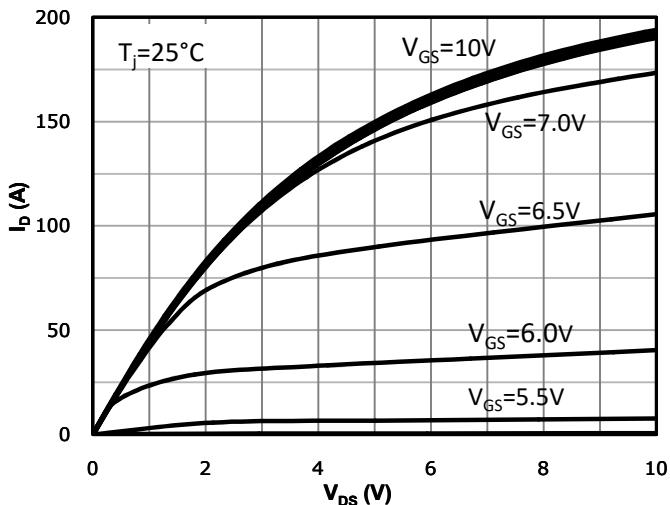


Fig 2: Transfer Characteristics

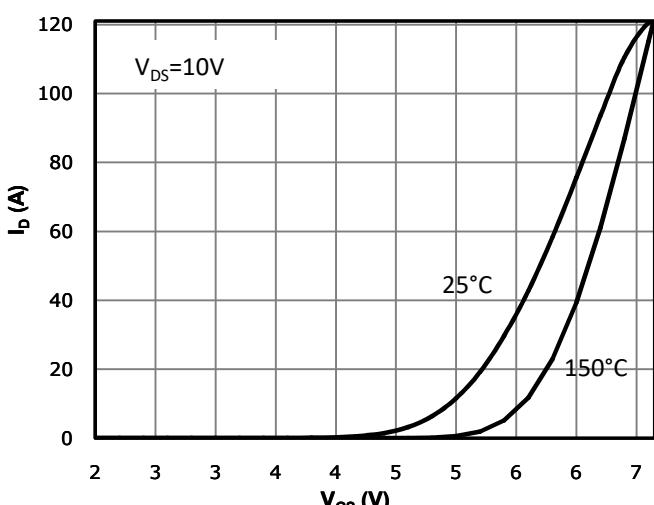


Fig 3: Rds(on) vs Drain Current and Gate Voltage

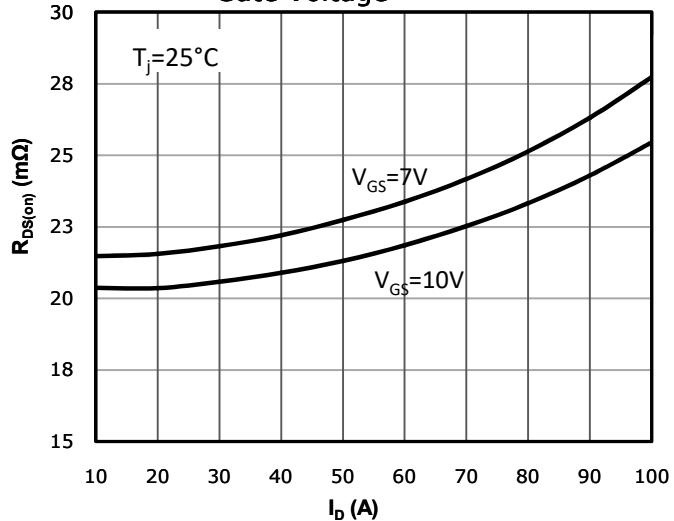


Fig 4: Rds(on) vs Gate Voltage

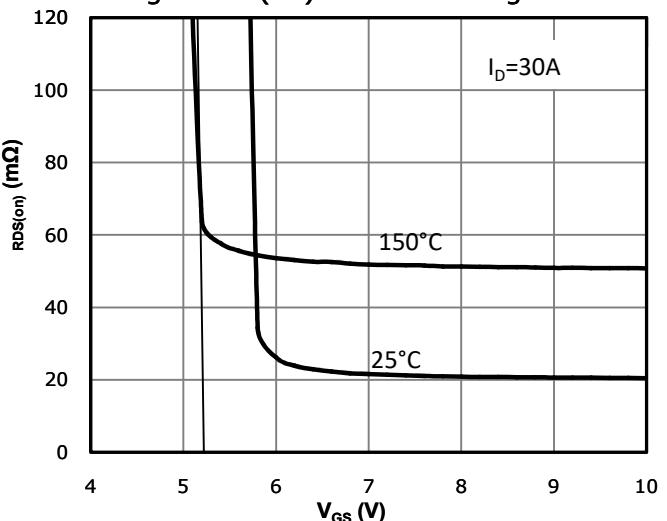


Fig 5: Rds(on) vs. Temperature

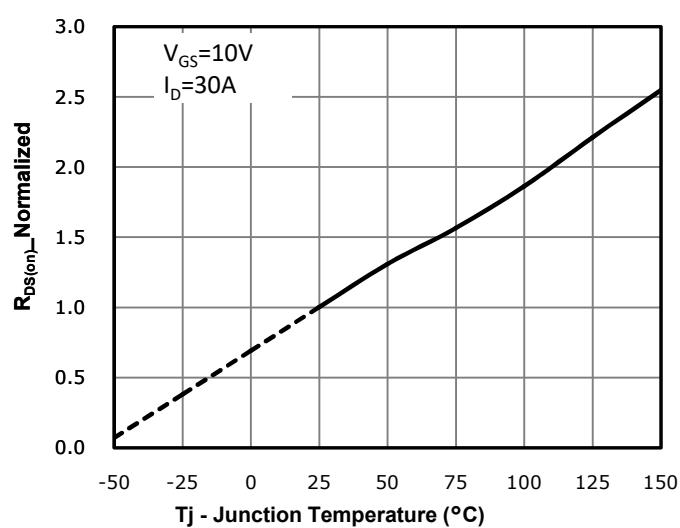


Fig 6: Capacitance Characteristics

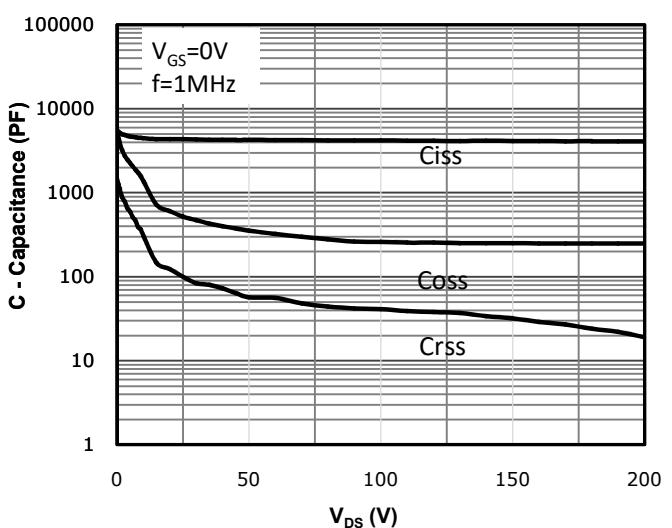


Fig 7: VTH vs. Temperature

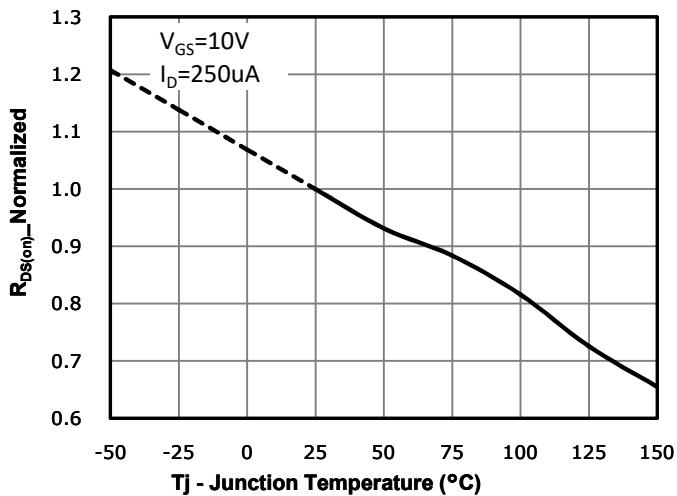


Fig 8: BVDS vs. Temperature

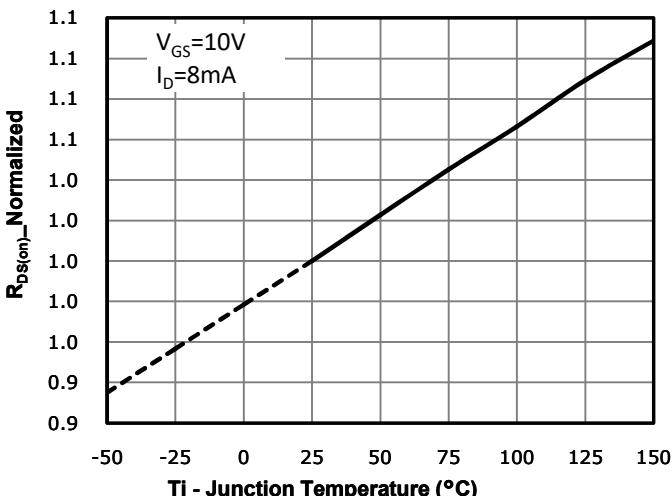


Fig 9: Gate Charge Characteristics

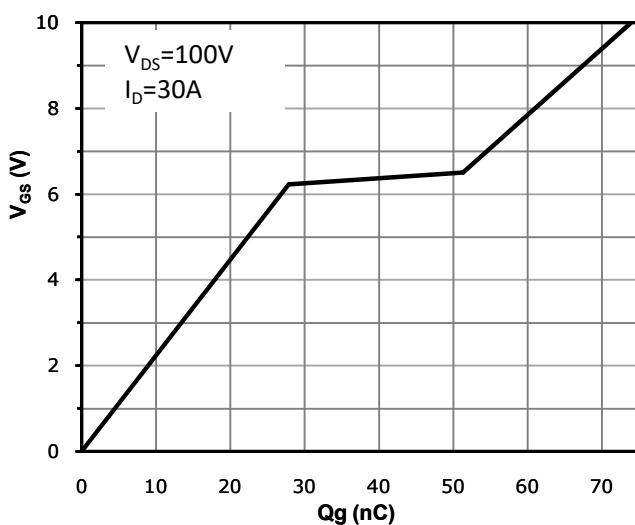


Fig 10: Body-diode Forward Characteristics

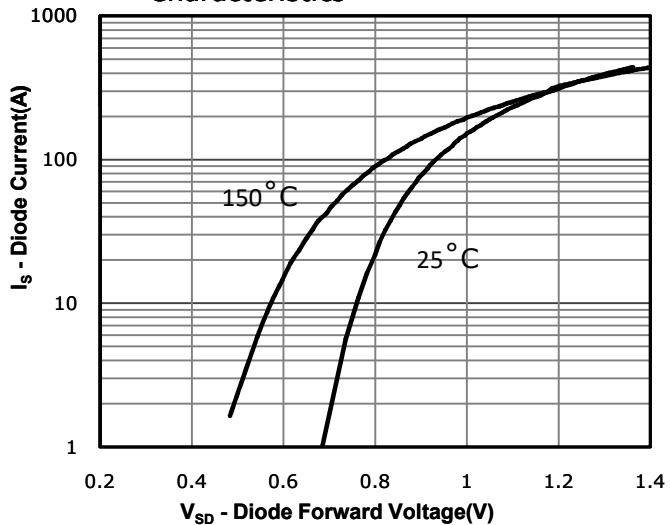


Fig 11: Power Dissipation

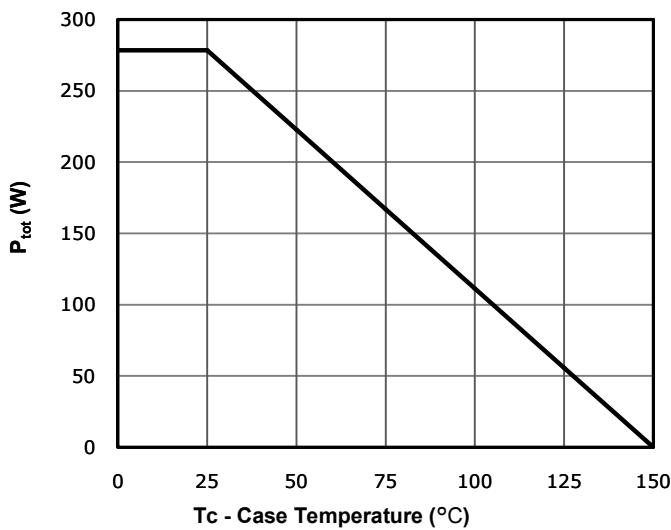


Fig 12: Drain Current Derating

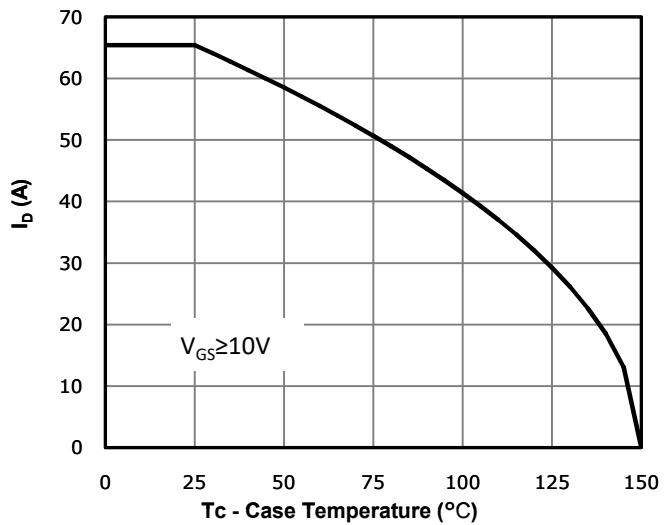


Fig 13: Safe Operating Area

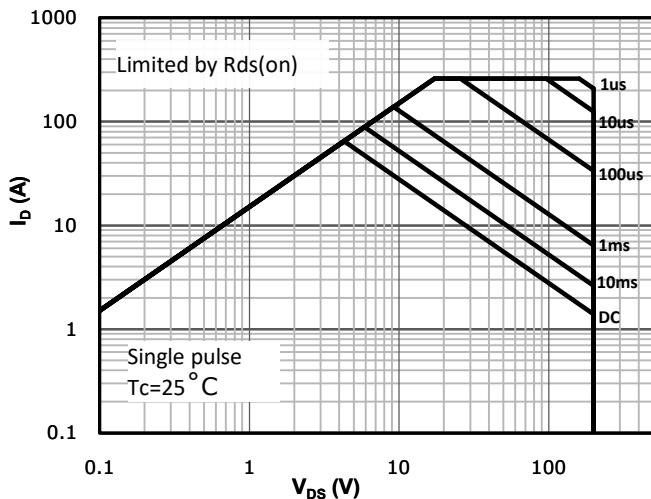
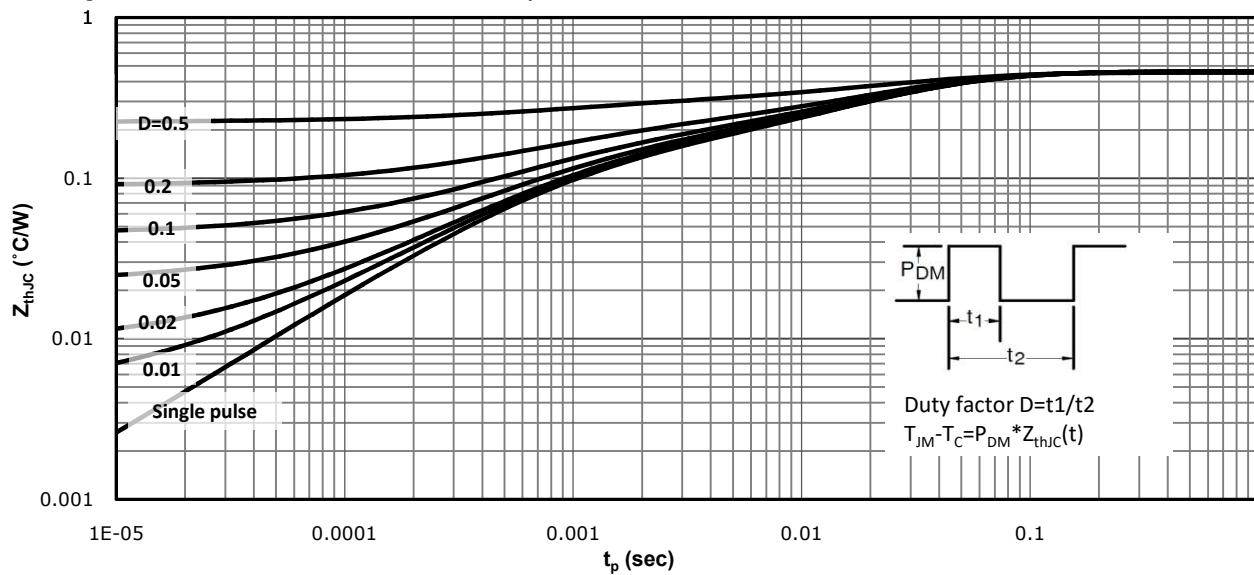
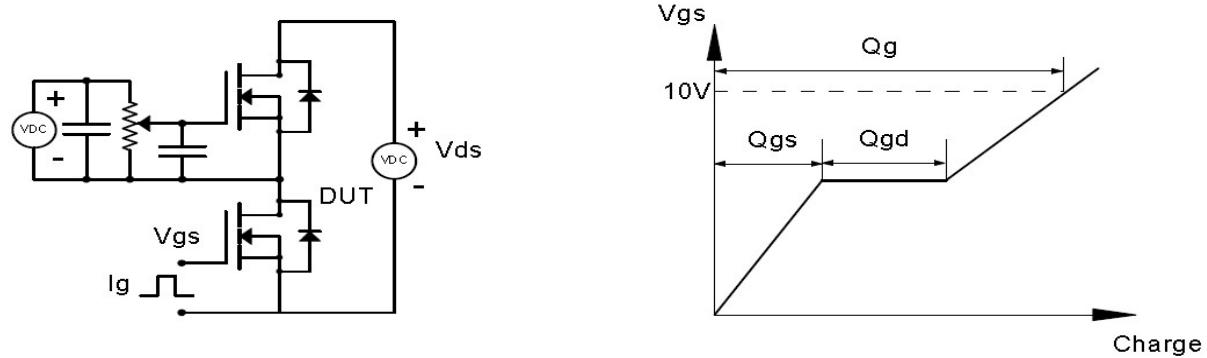


Fig 14: Max. Transient Thermal Impedance

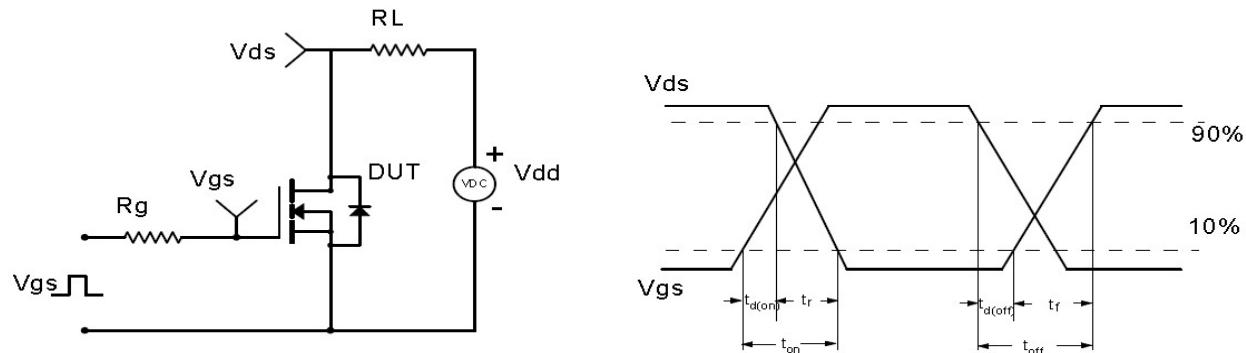


Test Circuit & Waveform

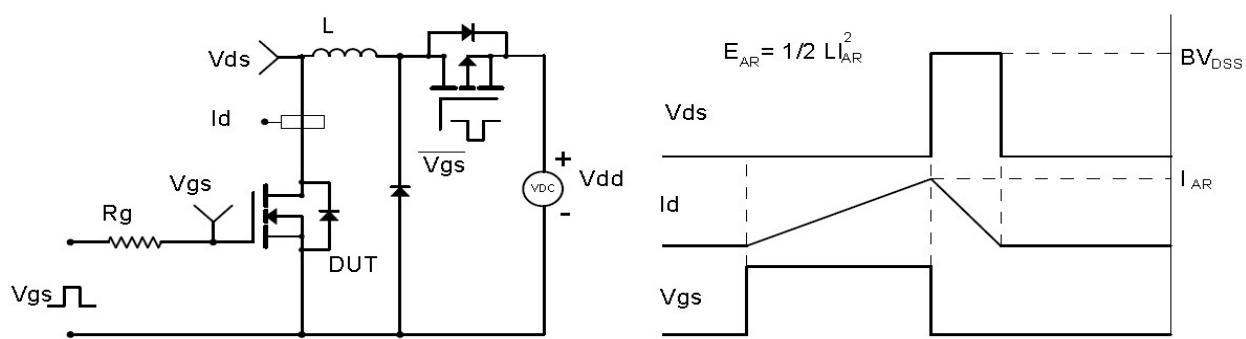
Gate Charge Test Circuit & Waveform



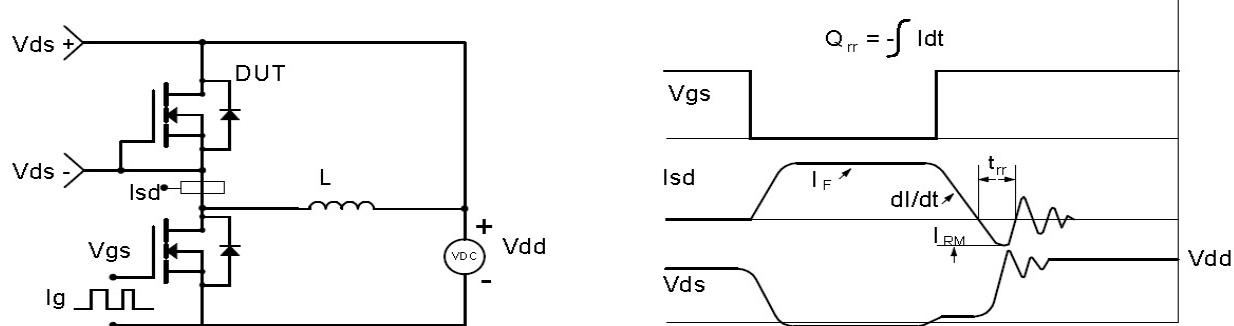
Resistive Switching Test Circuit & Waveforms

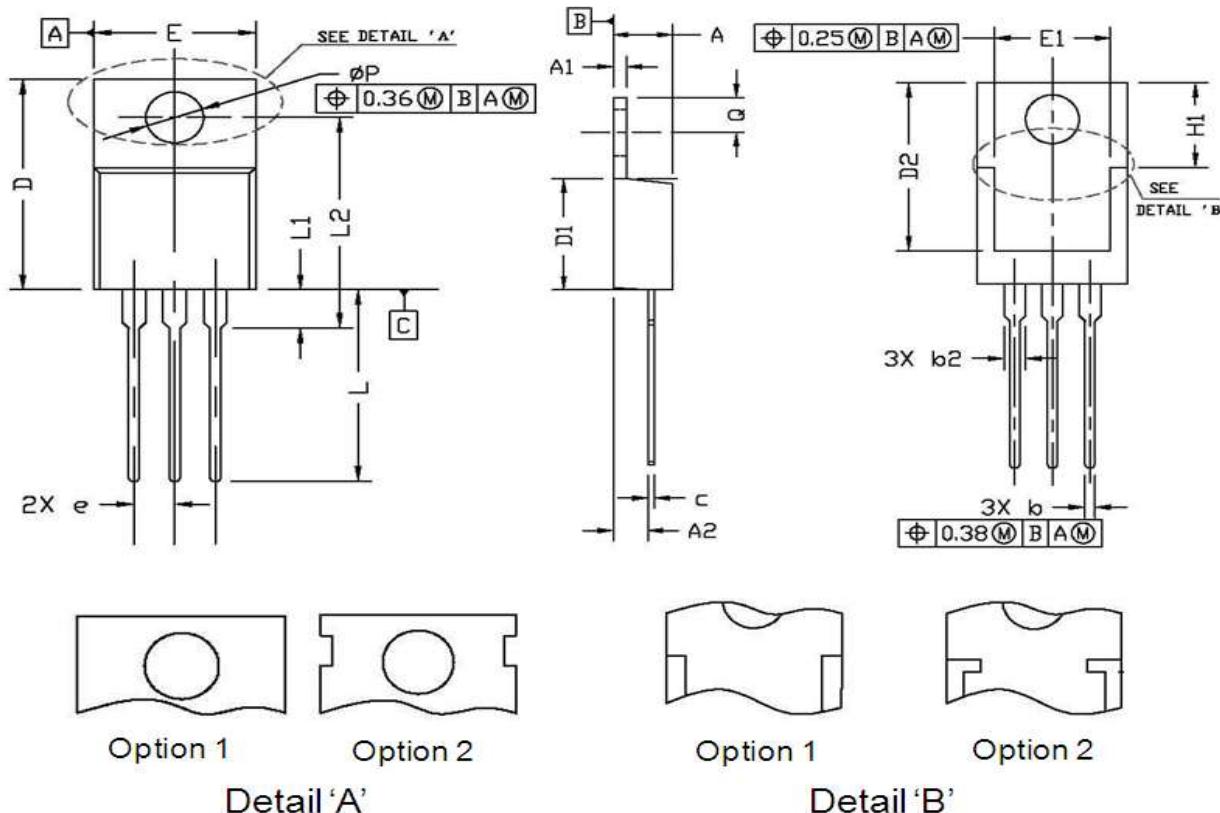


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: TO-220-3L


| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.30 | 4.80 | 0.169 | 0.189 |
| A1 | 1.20 | 1.45 | 0.047 | 0.057 |
| A2 | 2.20 | 2.90 | 0.087 | 0.114 |
| b | 0.69 | 0.95 | 0.027 | 0.037 |
| b2 | 1.00 | 1.60 | 0.039 | 0.063 |
| c | 0.33 | 0.65 | 0.013 | 0.026 |
| D | 14.70 | 16.20 | 0.579 | 0.638 |
| D1 | 8.59 | 9.65 | 0.338 | 0.380 |
| D2 | 11.75 | 13.60 | 0.463 | 0.535 |
| e | 2.54 BSC. | | 0.100 BSC. | |
| E | 9.60 | 10.60 | 0.378 | 0.417 |
| E1 | 7.00 | 8.46 | 0.276 | 0.333 |
| H1 | 6.20 | 7.00 | 0.244 | 0.276 |
| L | 12.60 | 14.80 | 0.496 | 0.583 |
| L1 | 2.70 | 3.80 | 0.106 | 0.150 |
| L2 | 12.13 | 16.50 | 0.478 | 0.650 |
| Q | 2.40 | 3.10 | 0.094 | 0.122 |
| P | 3.50 | 3.90 | 0.138 | 0.154 |



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Trench N-MOSFET 200V, 21mΩ, 65A

Revision History

| Revision | Date | Major changes |
|----------|-----------|---|
| 1.0 | 2023/1/11 | Release of formal version |
| 2.0 | 2023/3/20 | Add C _{iss} /C _{oss} /C _{rss} /R _g spec |

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.